



CERTIFICATE

ZIGBEE COMPLIANT PLATFORM

The ZigBee Alliance is pleased to congratulate Texas Instruments, Inc. on the completion of the ZigBee Certification Program testing of the following product:

| | |
|--------------------------------|--------------------------------------|
| Type of Device | ZigBee PRO Feature Set |
| Manufacturer | Texas Instruments, Inc. |
| Model Identification | Z-Stack2.6.1SmartRF05EBCC2530 |
| Firmware Version | 2.6.1 |
| Hardware version | SmartRF05EB + CC2530 |
| Certification Date | January 7, 2014 |
| Certification ID Number | ZIG14002ZCP26882-24 |

This Certificate serves to confirm that the above mentioned product has passed all relevant tests in conjunction with the ZigBee Certification Program and is deemed compliant to it. The manufacturer has been granted the right to use the following term and all associated logos:

ZigBee Compliant Platform

The usage of this term is limited to the described device and does not encompass any changes, firmware upgrades or subsequent versions and models after the listed test date.

All usage guidelines for the ZigBee Logo also apply to the term above.

We congratulate you on the completion of the program!

Sincerely,

ZigBee Alliance

January 7, 2014

Date

Signature

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